

# VHF variable capacitance diode Rev. 03 — 24 February 2009

**Product data sheet** 

### **Product profile**

#### 1.1 General description

The BB182 is a planar technology variable capacitance diode in a SOD523 (SC-79) ultra small plastic package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

#### 1.2 Features

- High linearity
- Excellent matching to 2 % DMA
- Ultra small plastic SMD package
- $C_{d(28V)}$ : 2.7 pF;  $C_{d(1V)}$  to  $C_{d(28V)}$  ratio: 22
- Low series resistance

#### 1.3 Applications

- Electronic tuning in VHF television tuners, Band A up to 160 MHz
- Voltage Controlled Oscillators (VCO)

#### **Pinning information** 2.

Table 1. **Pinning** 

Pin	Description	Simplified outline	Graphic symbol	
1	cathode	[1]	JL	
2	anode	1 2	+	
			sym008	

<sup>[1]</sup> The marking bar indicates the cathode.

# 3. Ordering information

Table 2. **Ordering information** 

Type number	Package			
	Name	Description	Version	
BB182	SC-79	plastic surface-mounted package; 2 leads	SOD523	



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# 4. Marking

Table 3. Marking codes

Type number	Marking code
BB182	2

# 5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	reverse voltage		-	32	V
		peak value in series with a 10 $k\Omega$ resistor	-	35	V
I <sub>F</sub>	forward current		-	20	mΑ
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

### 6. Characteristics

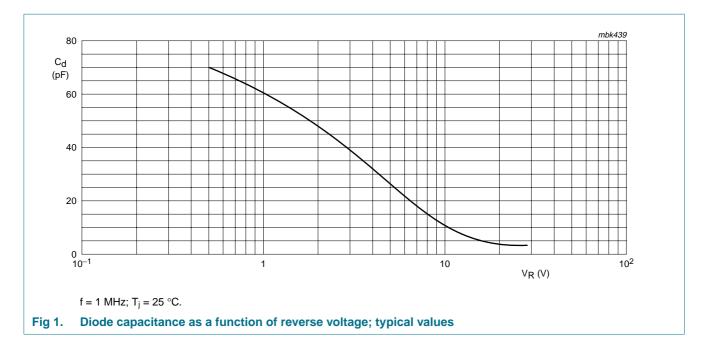
Table 5. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$I_R$	reverse current	see Figure 2				
		$V_R = 30 \text{ V}$	-	-	10	nΑ
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	-	-	200	nΑ
r <sub>s</sub>	diode series resistance	$f = 100 \text{ MHz}$ at $C_d = 30 \text{ pF}$	-	1.0	1.2	Ω
$C_d$	diode capacitance	f = 1 MHz; see <u>Figure 1</u> and <u>Figure 3</u>				
		$V_R = 1 V$	52	-	62	pF
		V <sub>R</sub> = 28 V	2.48	2.7	2.89	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz	-	1.31	-	
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	f = 1 MHz	20.6	22	-	
C <sub>d(25V)</sub> /C <sub>d(28V)</sub>	diode capacitance ratio (25 V to 28 V)	f = 1 MHz	-	1.05	-	
$\Delta C_d/C_d$	diode capacitance matching	V <sub>R</sub> = 1 V to 28 V; in a sequence of 10 diodes (gliding)	-	-	2	%

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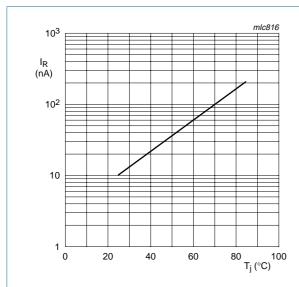
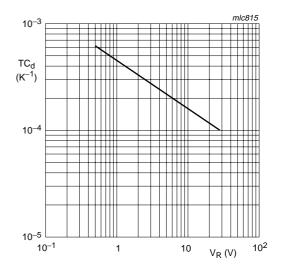


Fig 2. Reverse current as a function of junction temperature; maximum values



 $T_j = 0$  °C to 85 °C.

Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values

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# 7. Package outline

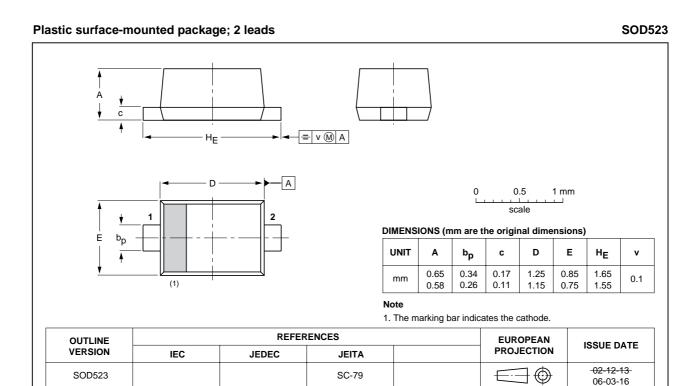


Fig 4. Package outline SOD523 (SC-79)

#### 8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface-Mounted Device
VHF	Very High Frequency

# 9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB182_3	20090224	Product data sheet	-	BB182_2
Modifications:	guidelines of	of this data sheet has been red f NXP Semiconductors have been adapted to the new	0 17	•
BB182_2	20041103	Product data sheet	-	BB182_1
BB182_1	19971113	Product specification	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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